

Title (en)
COPPER ALLOY SHEET

Title (de)
KUPFERLEGIERUNGSBLECH

Title (fr)
TÔLE EN ALLIAGE DE CUIVRE

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Application
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Abstract (en)
The present invention relates to a Cu-Ni-Sn-P-based copper alloy sheet having a specific composition, where the dislocation density measured using the value obtained by dividing the half-value breadth of the X-ray diffraction intensity peak from {200} plane in the copper alloy sheet surface by the peak height is set to a given value or more and press punchability is thereby enhanced. The Cu-Ni-Sn-P-based copper alloy sheet of the present invention is excellent in the properties required for a terminal or connector and further has excellent press punchability.

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Citation (applicant)

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